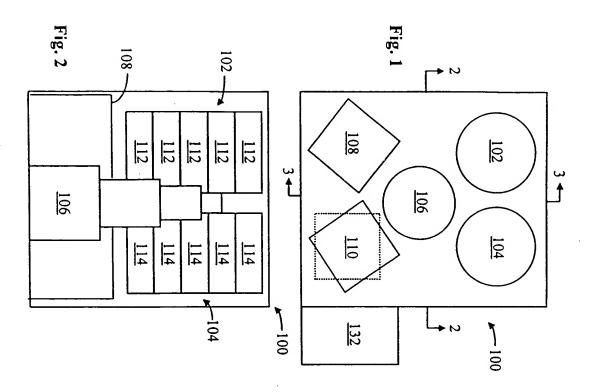
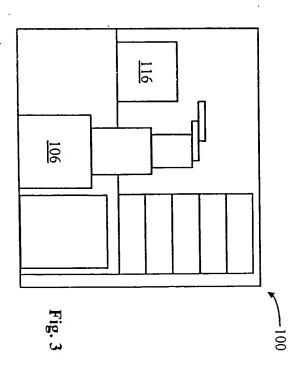
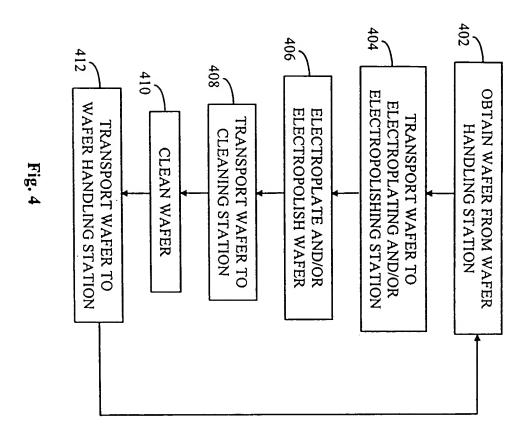
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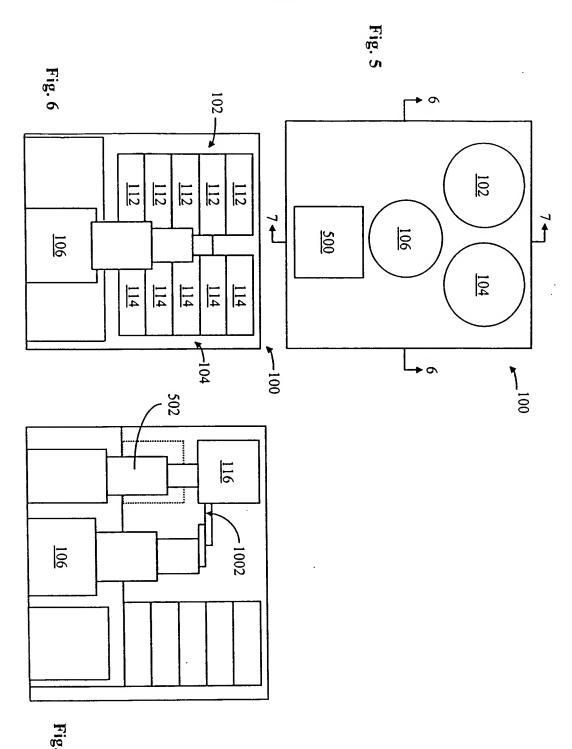


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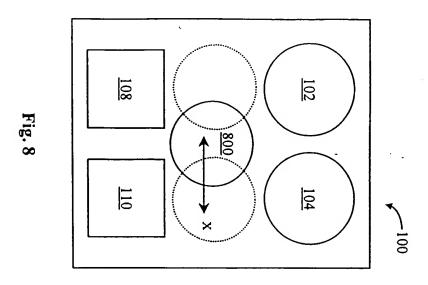
AND POSITIONING SEMICONDI ICTOR WOLKING
AND POSITIONING SEMICONDI ICTOR WORK PIECES
DURING ELECTROPOLISHING AND/OR
ELECTROPLATING OF THE WORKPIECES
Inventor: Hui WANG et al.
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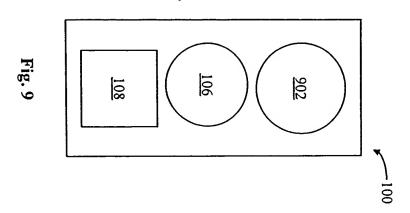
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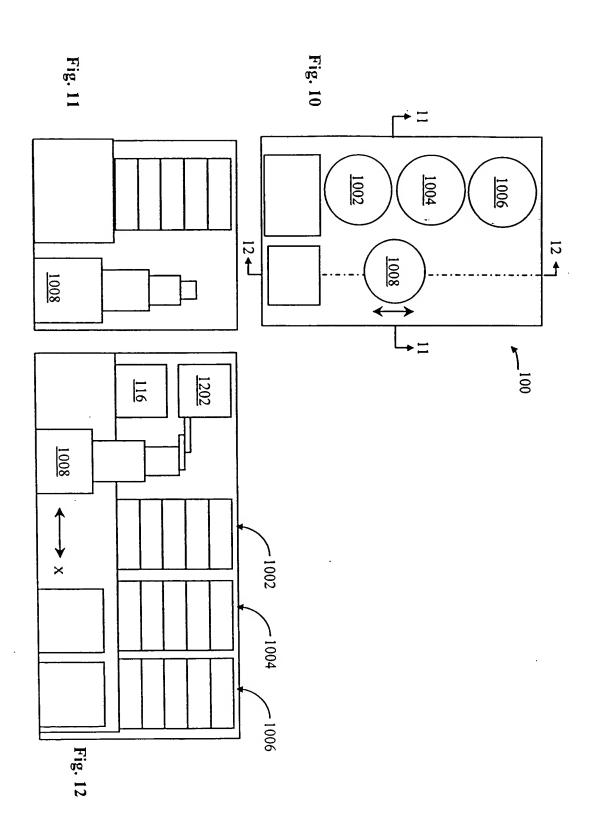
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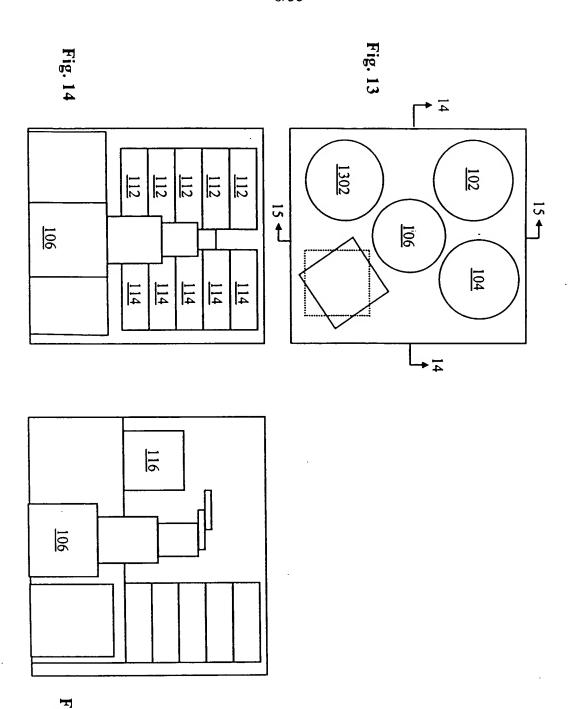
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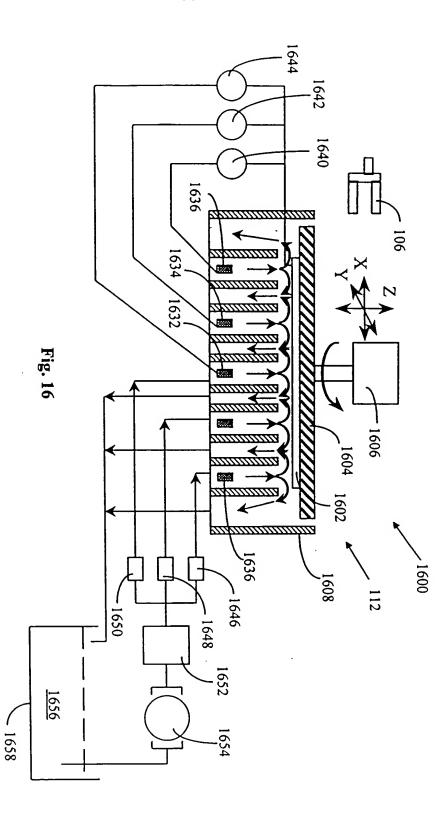
AND POSITIONING SEMICONNII (TOR WORKPIECES DURING ELECTROPOLISHING AND/OR ELECTROPOLISHING AND/OR ELECTROPLATING OF THE WORKPIECES Inventor: Hui WANG et al.

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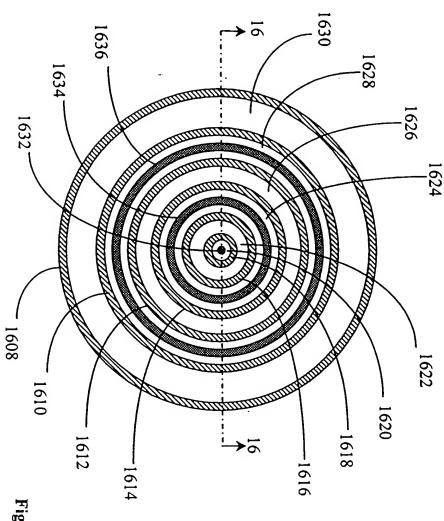
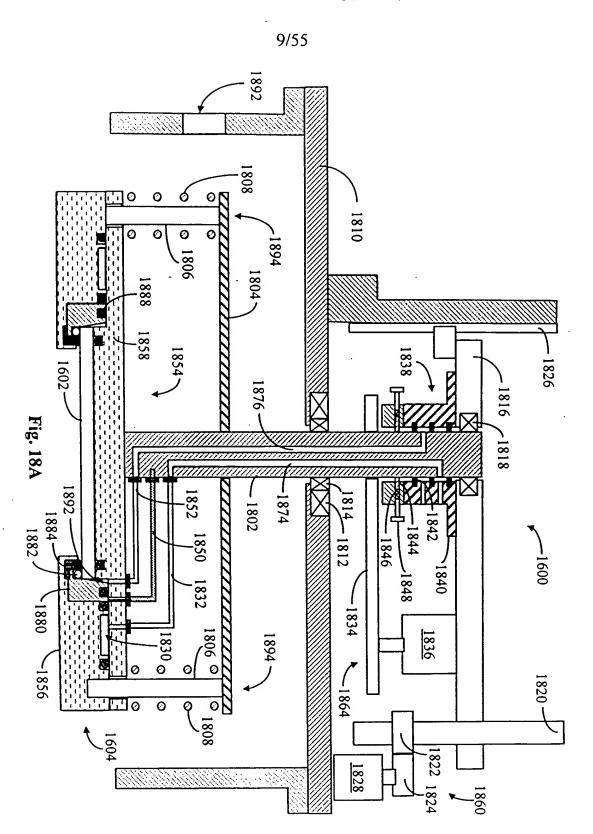


Fig. 17

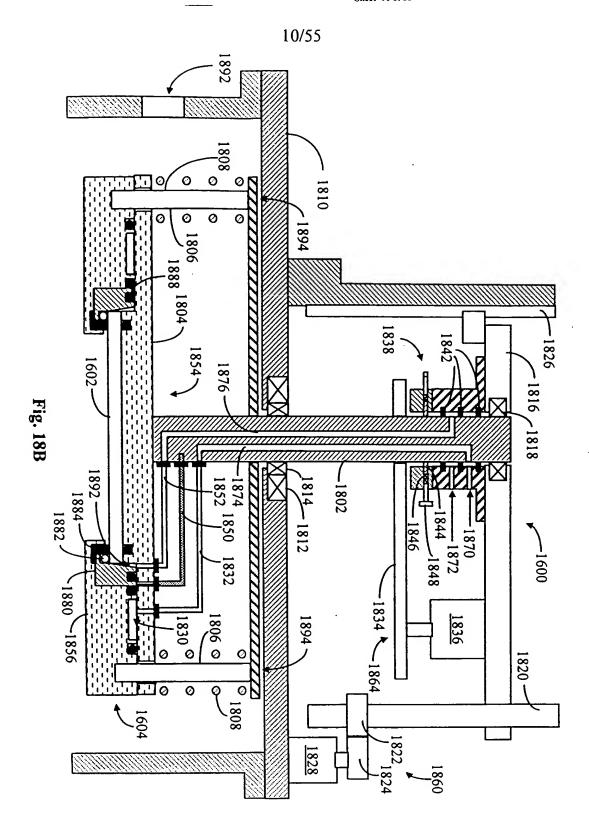
Title: METHODS AND APPARATUS FOR HOLDING AND POSITIONING SEMICONBUCTOR WORKPIFCES DURING ELECTROPOLISHING AND/OR ELECTROPLATING OF THE WORKPIECES Inventor: Hui WANG et al.

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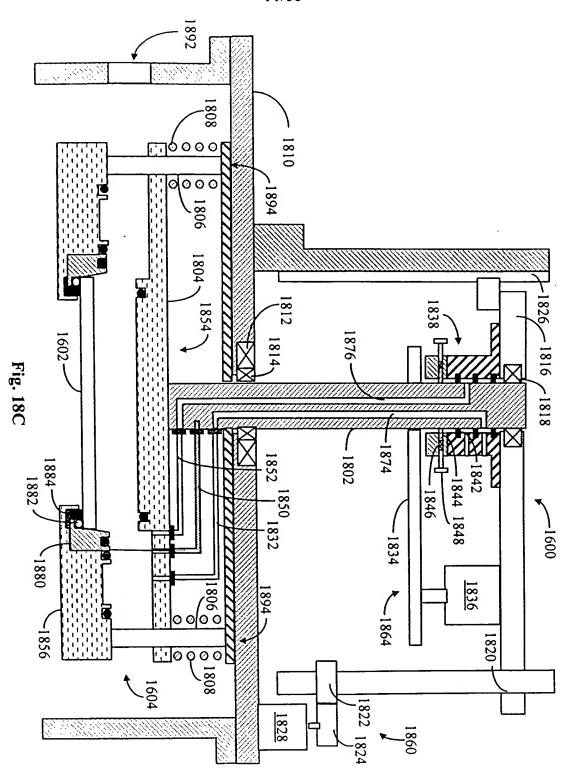
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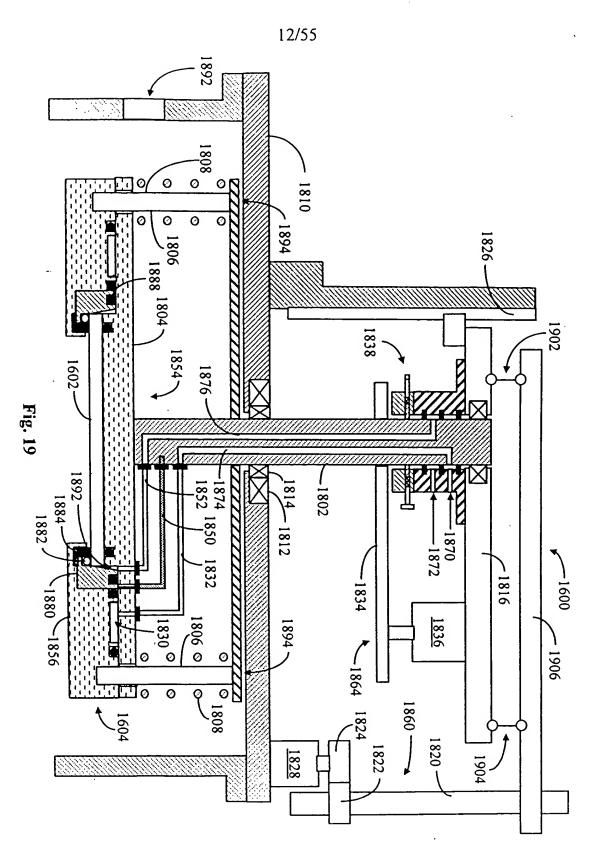
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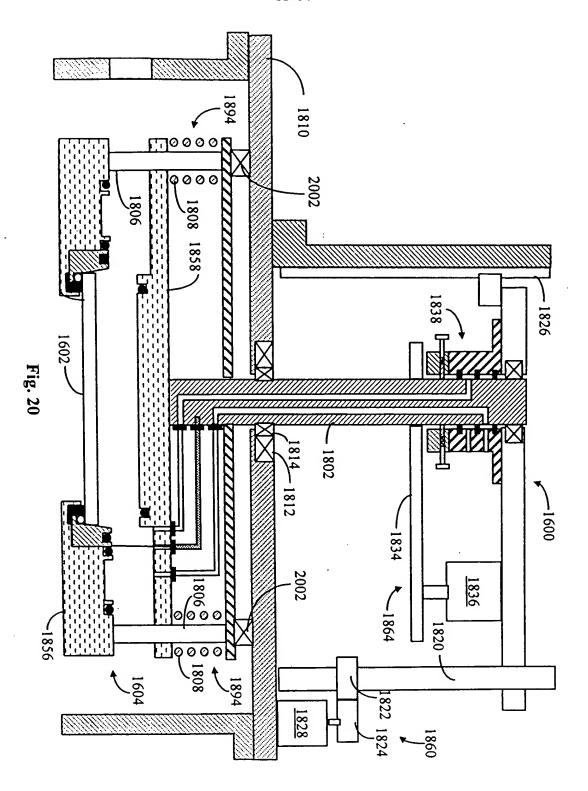
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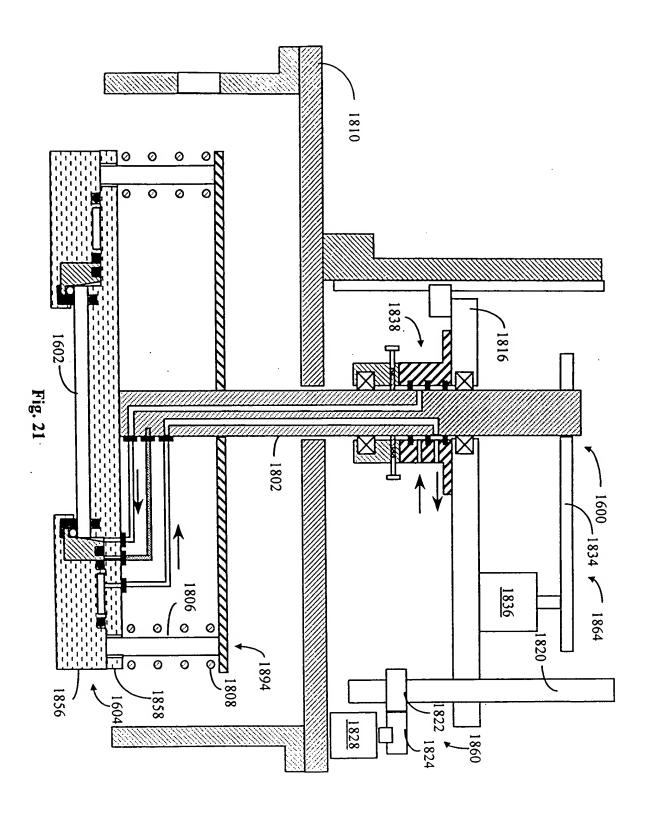
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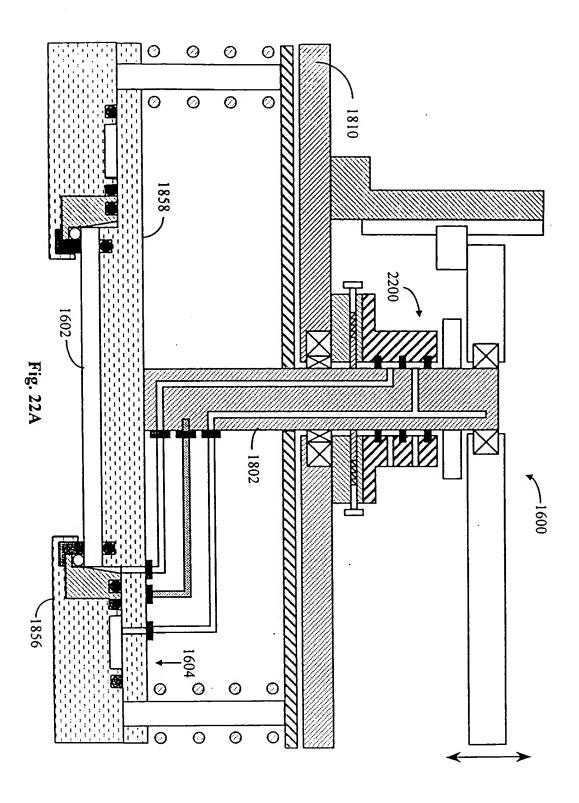
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AND POSITIONING SEMICONDUCTOR
WORKPIECES DURING ELECTROPOLISHING
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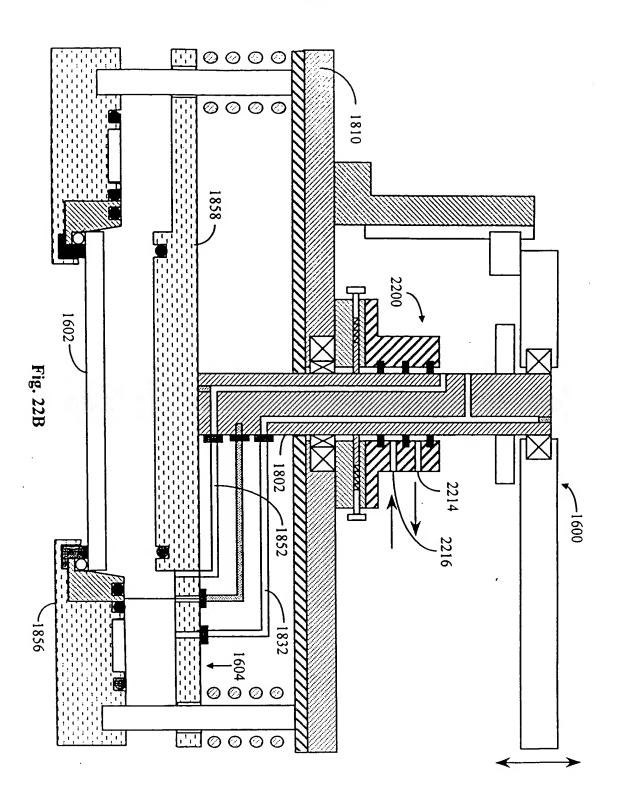
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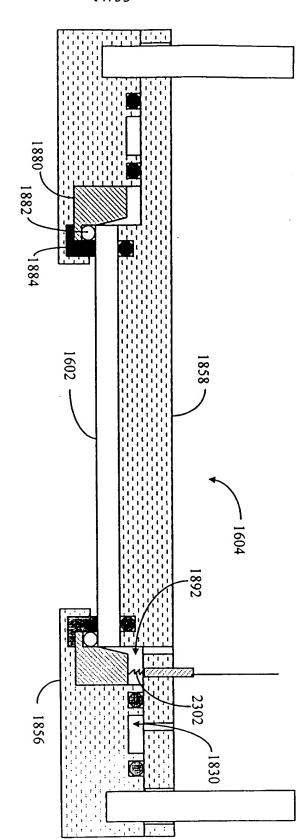
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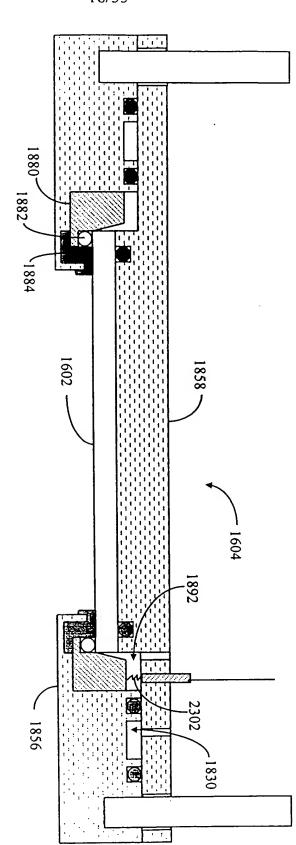


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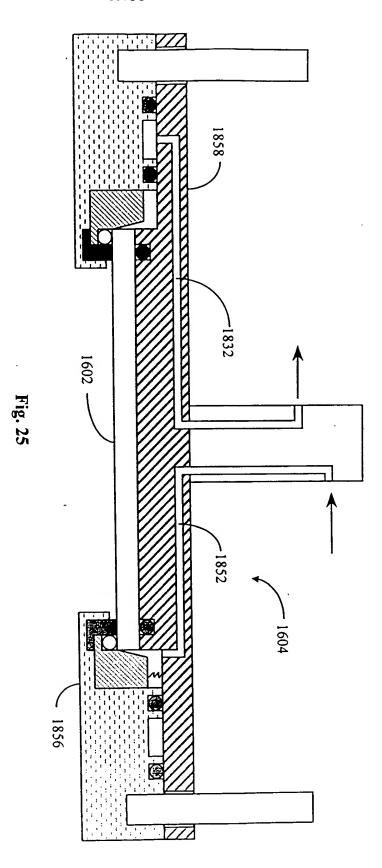
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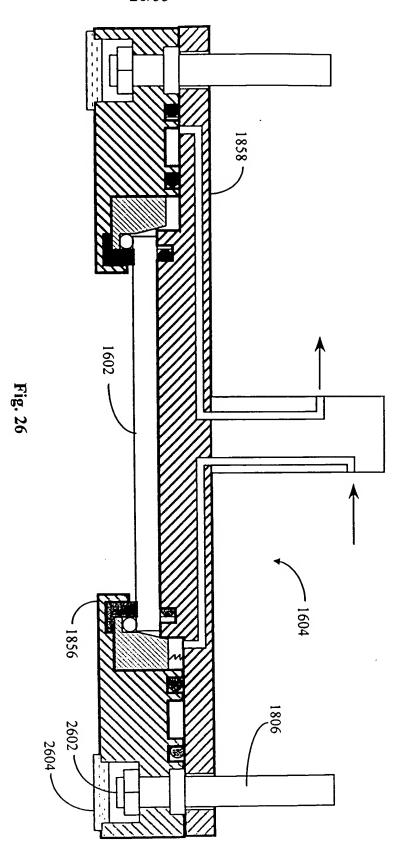
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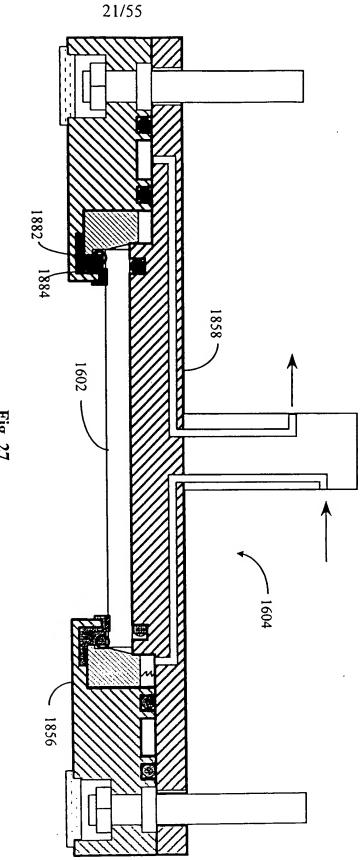


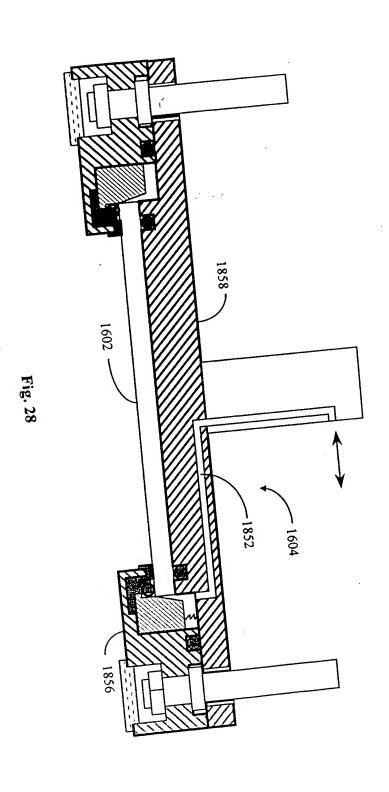
AND POSITIONING SEMICONDUCTOR
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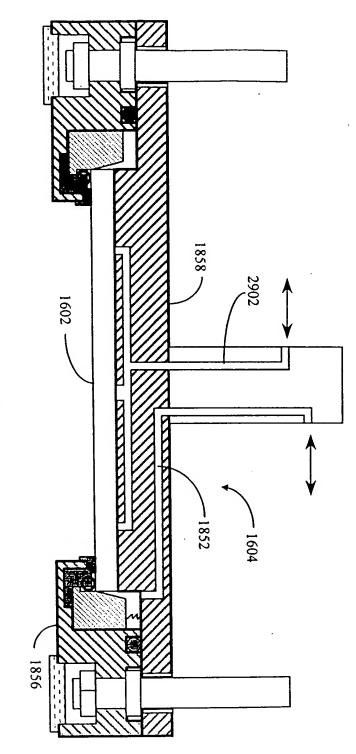


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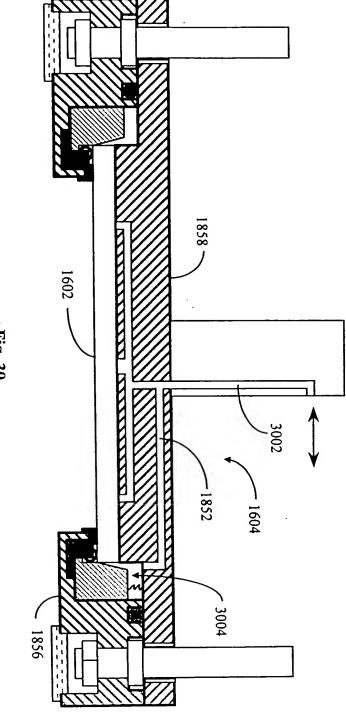
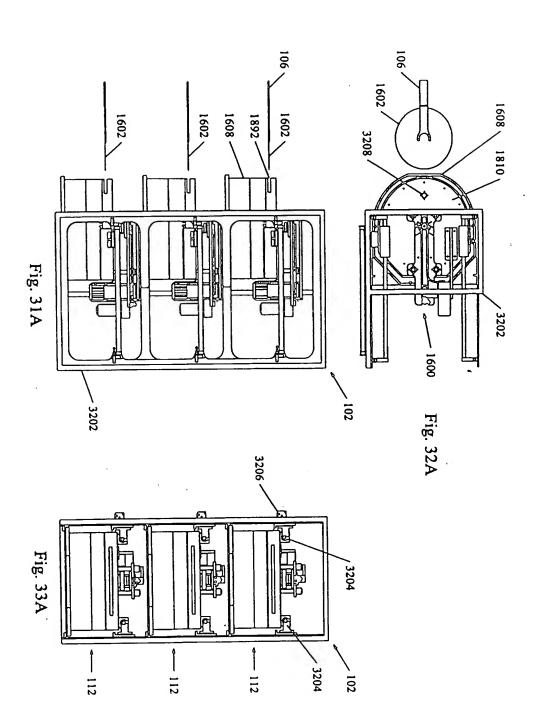
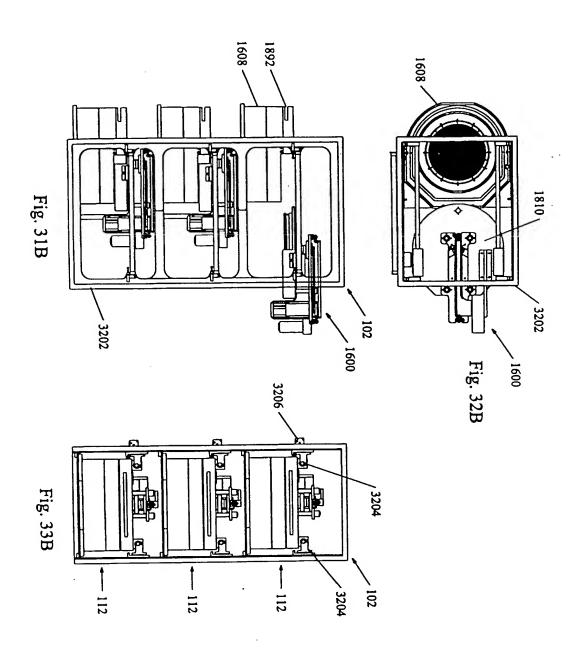


Fig. 30

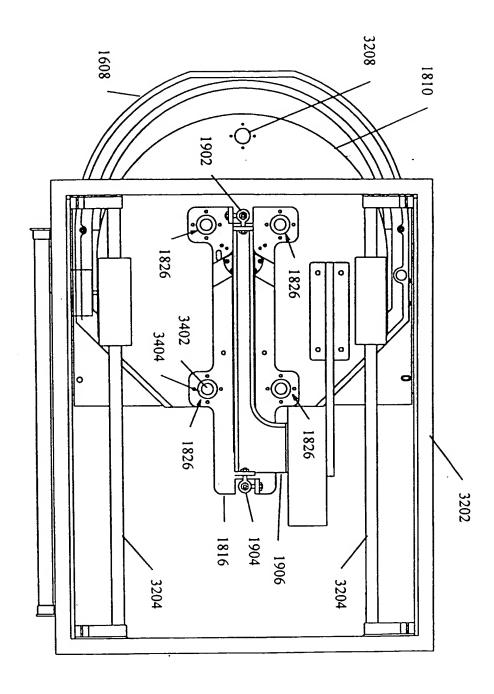
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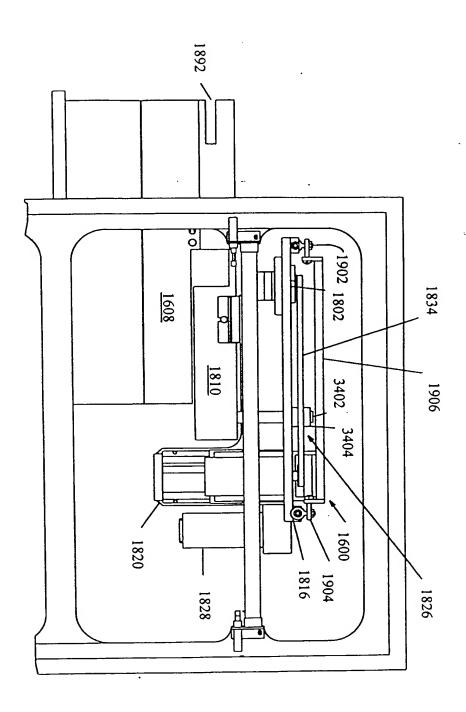
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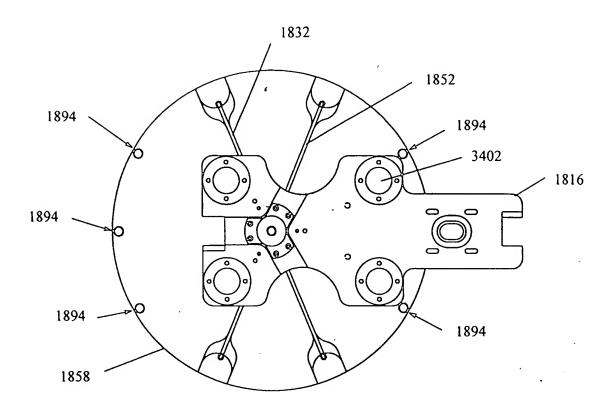


Fig. 36

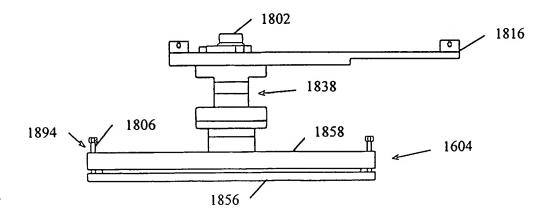


Fig. 37

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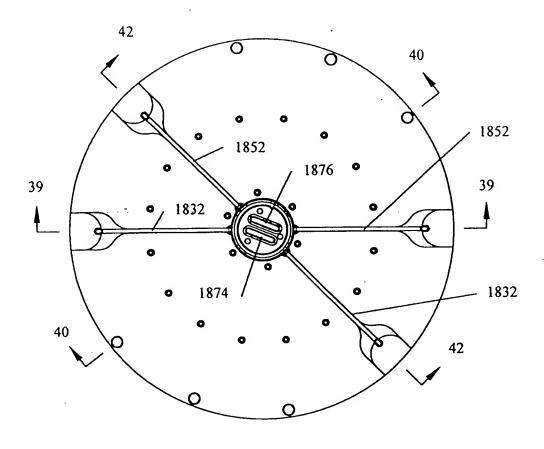


Fig. 38

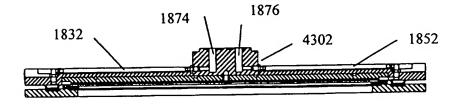
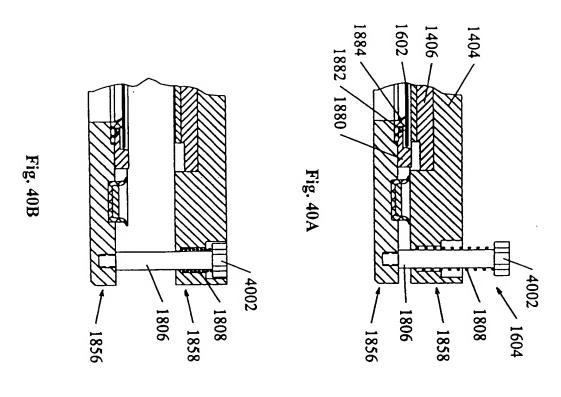
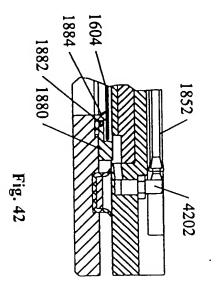
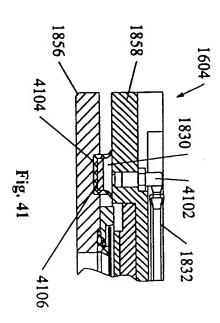


Fig. 39

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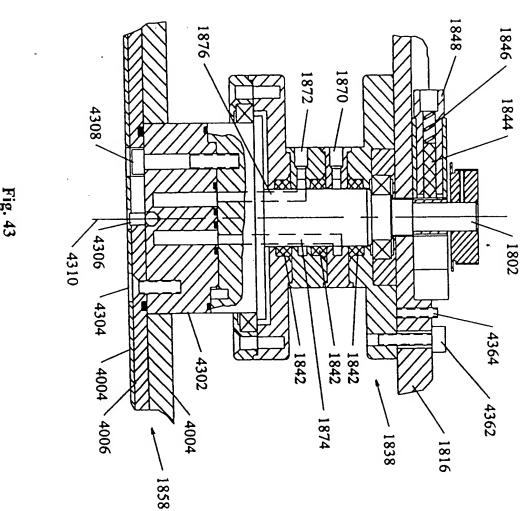






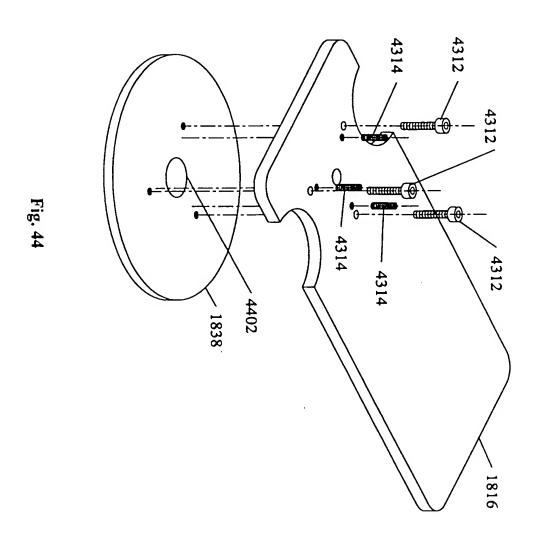
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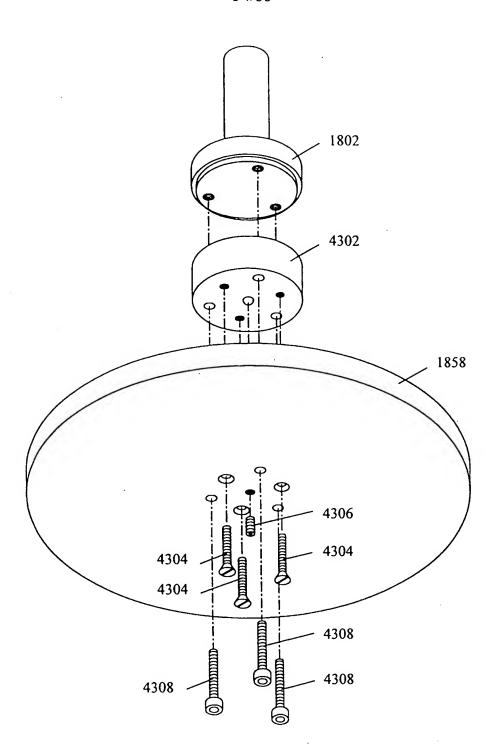
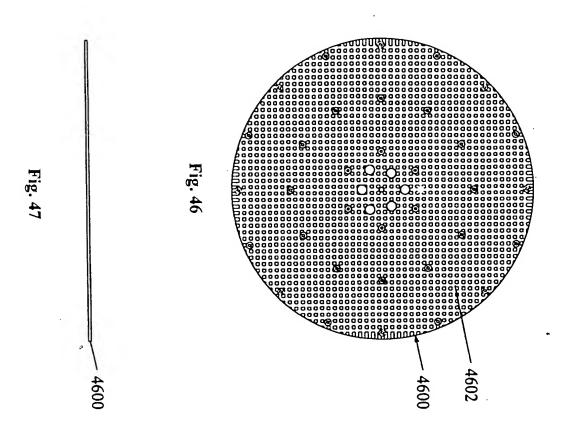


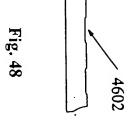
Fig. 45

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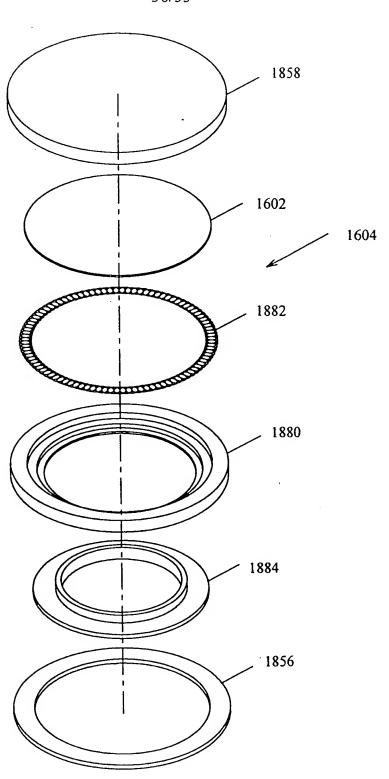


Fig. 49

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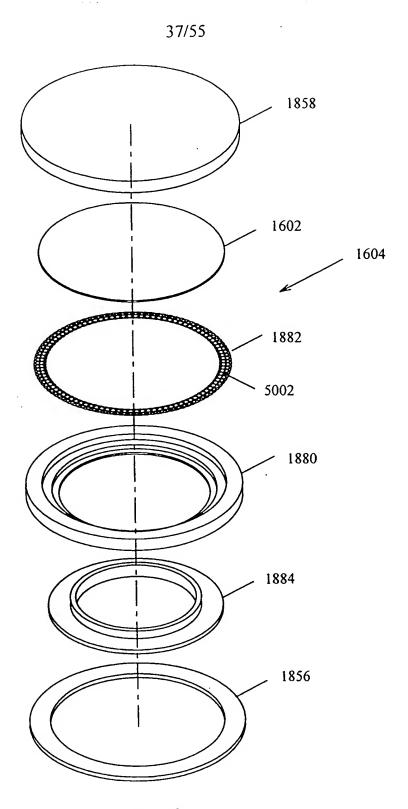
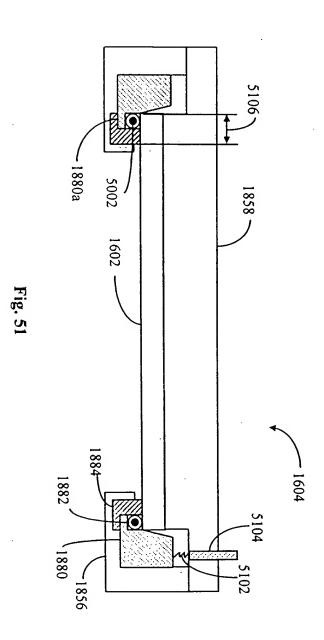


Fig. 50

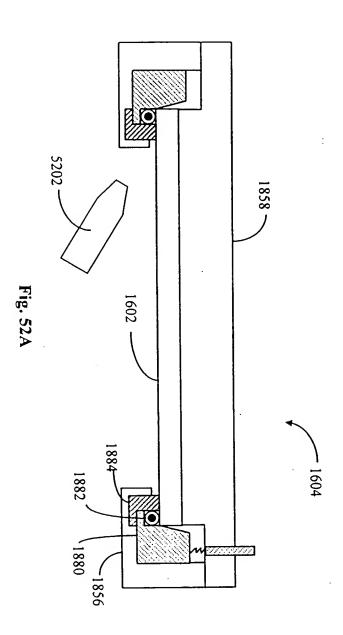
Title: METHODS AND APPARATUS FOR HOLDING AND POSITIONING SEMICONDUCTOR WORKPIECES DURING ELECTROPOLISHING AND/OR ELECTROPLATING OF THE WORKPIECES Inventor: Hui WANG et al.

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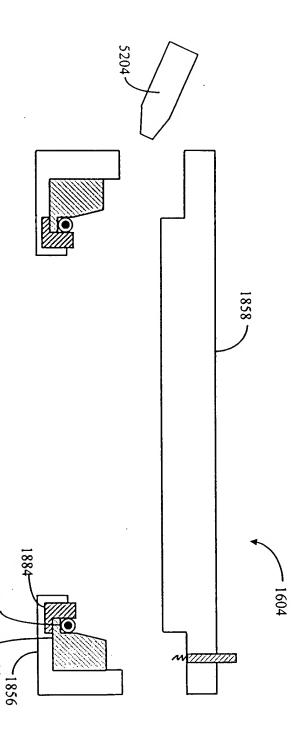
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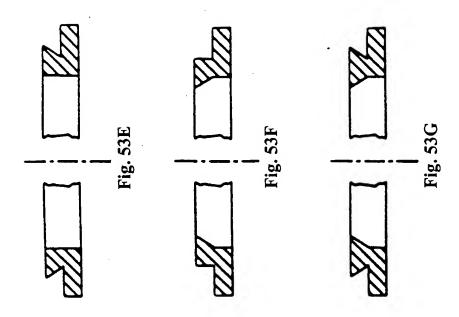
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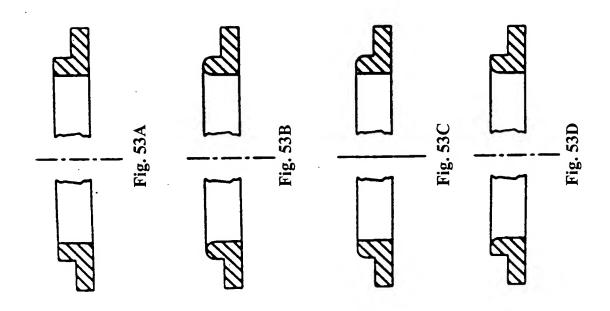


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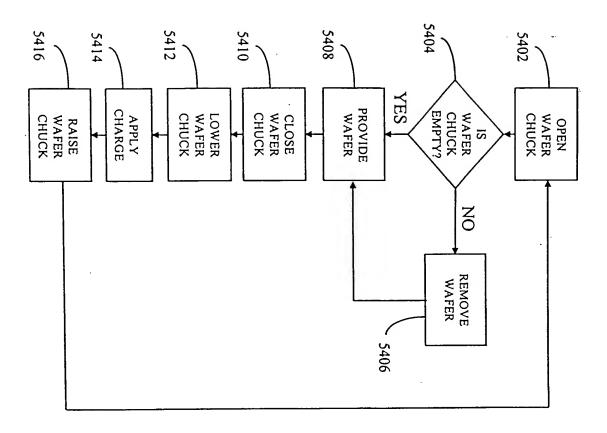
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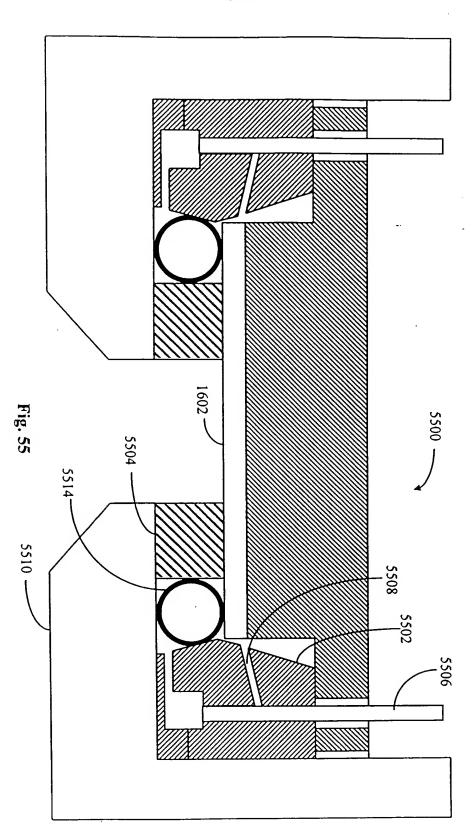
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Fig. 54



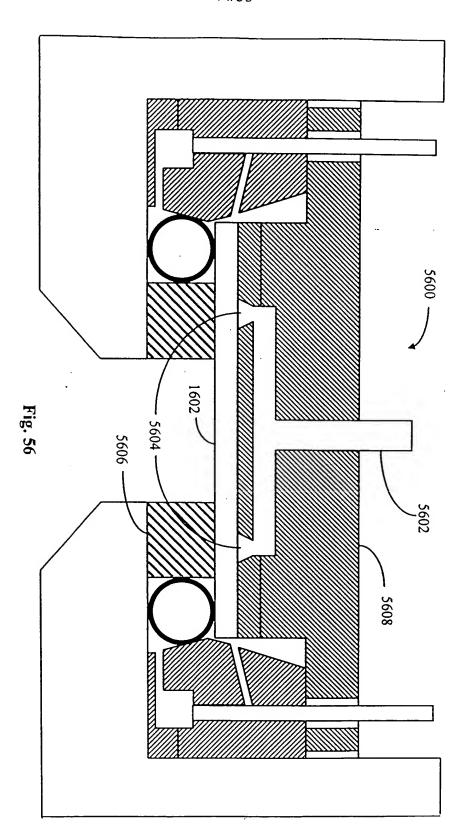
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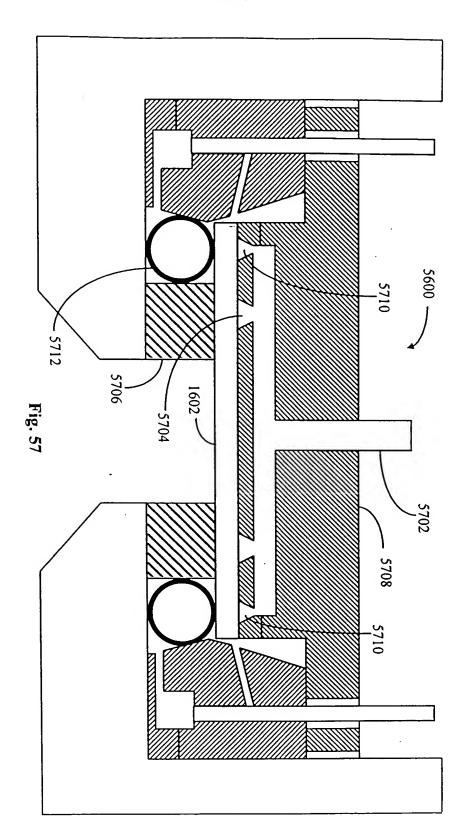
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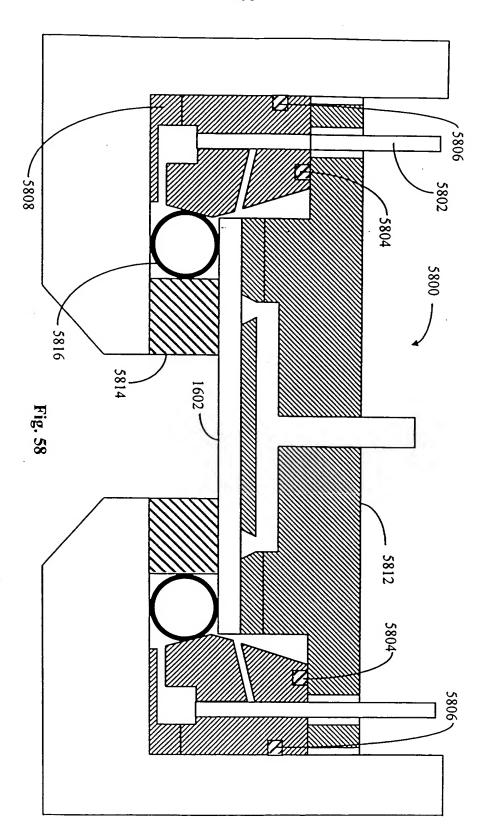
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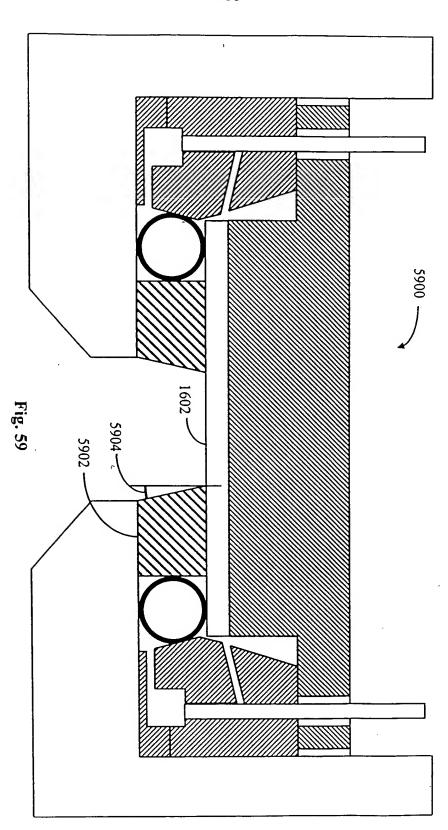
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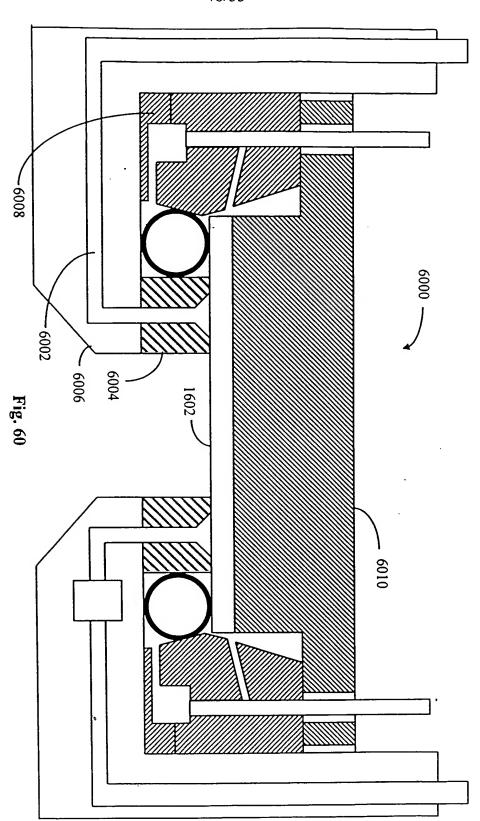


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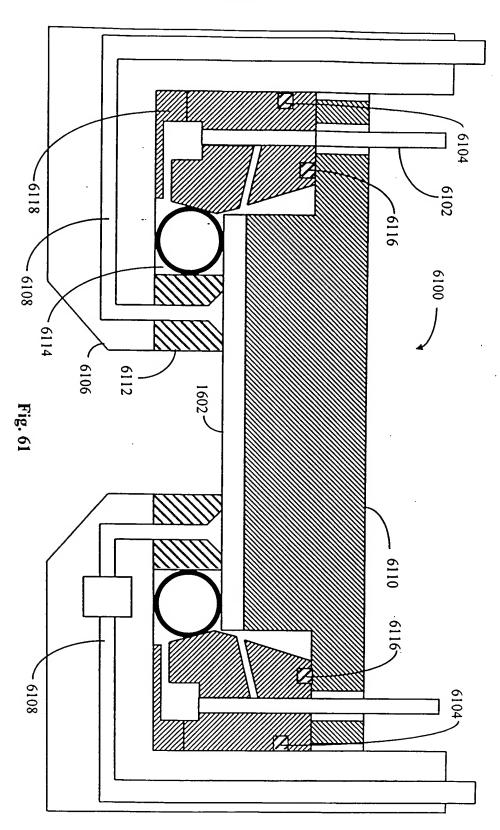


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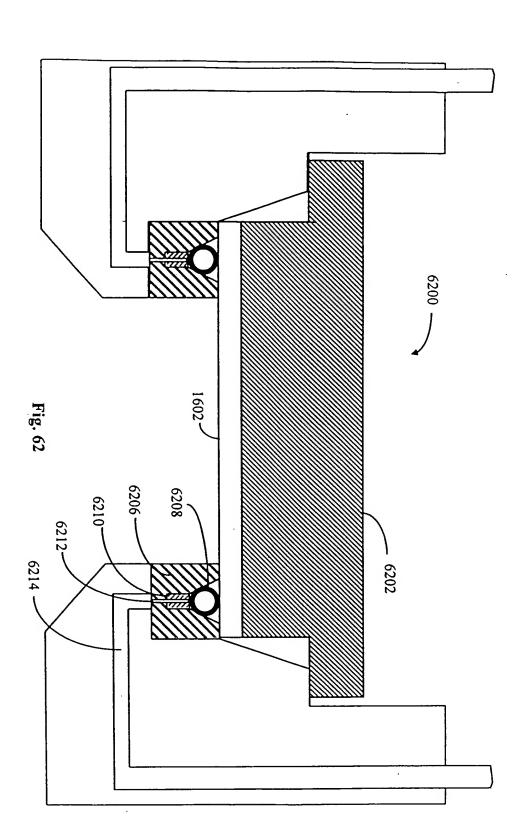


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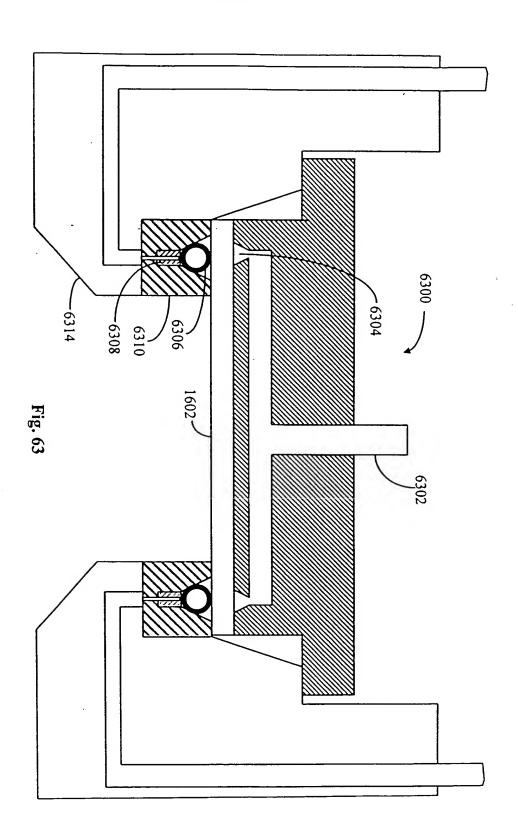
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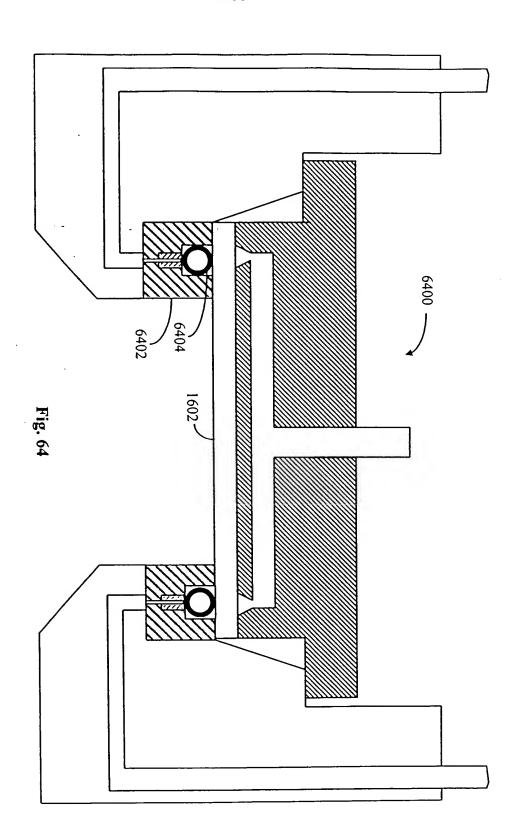
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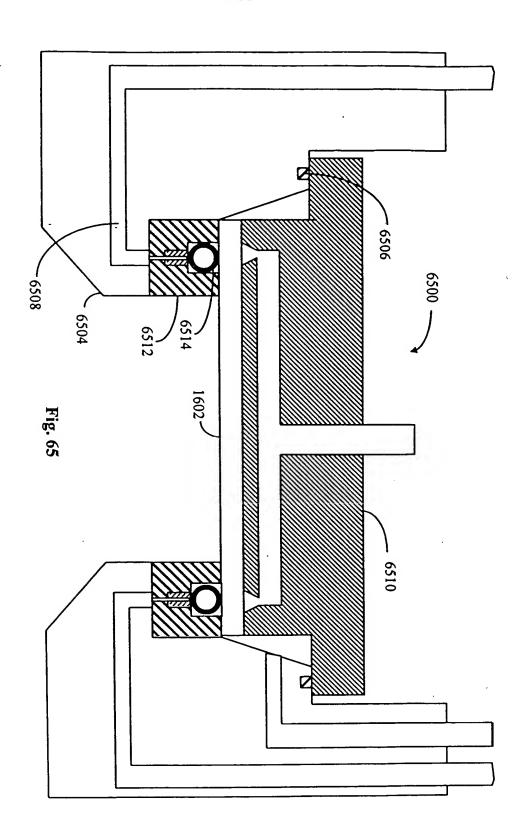
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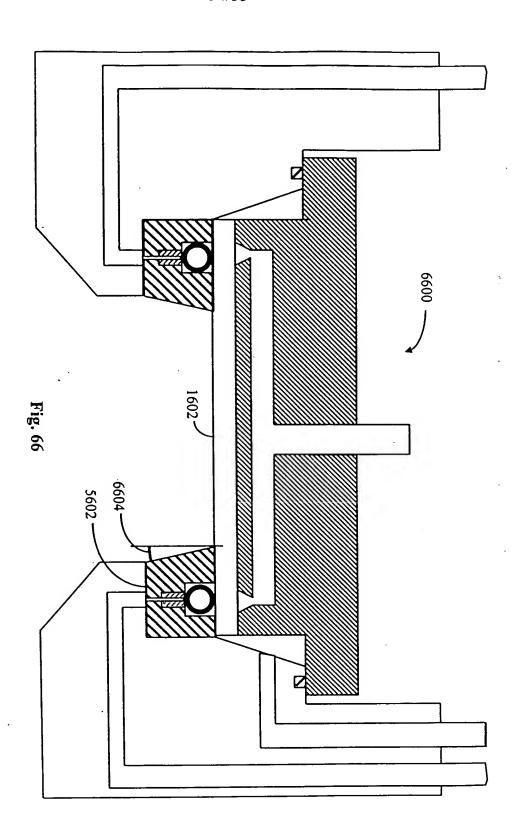
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